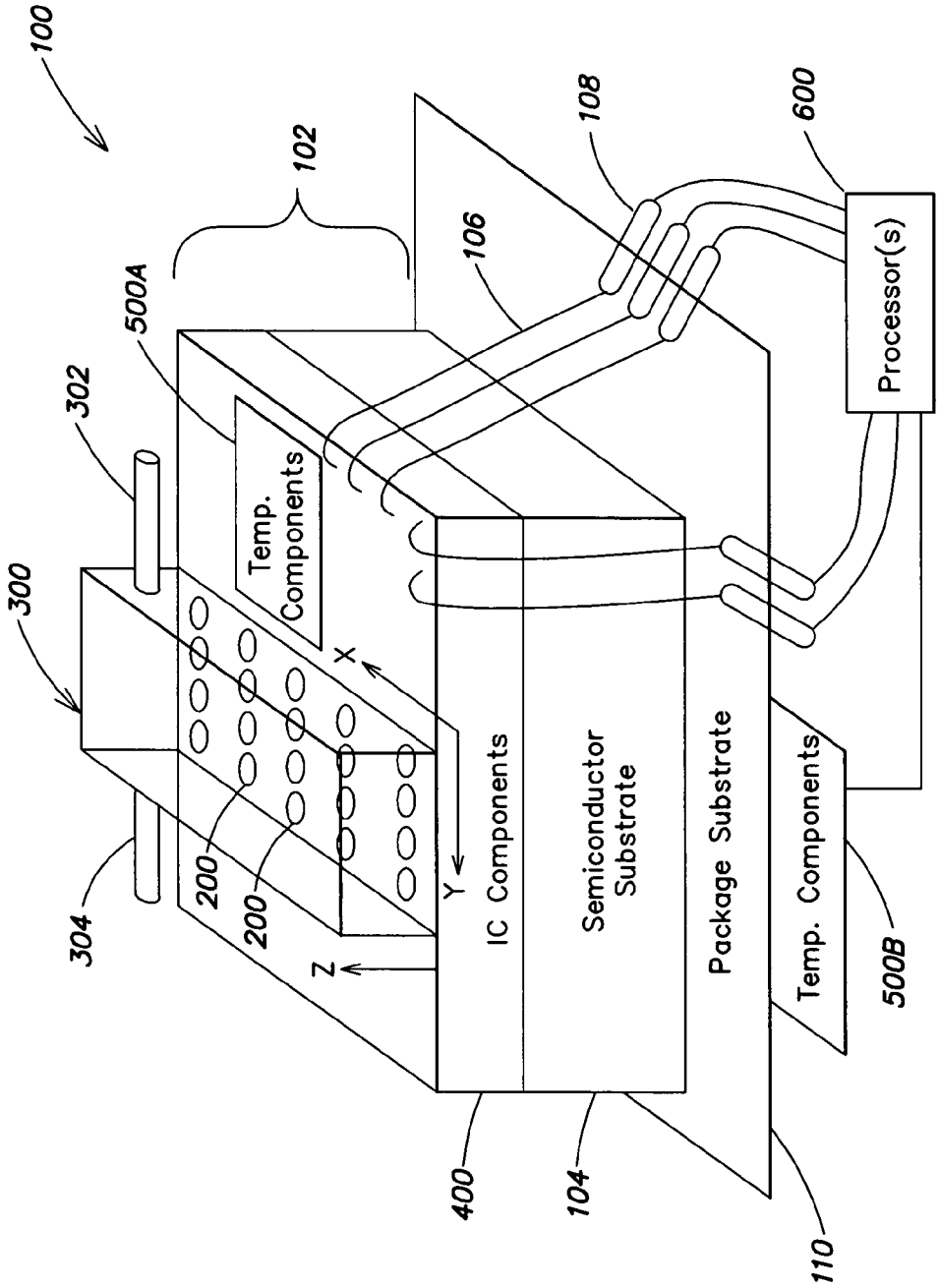
100
102
108
600
106
500A
302
300
Temp. Components
Processor(s)
X
Y
Z
IC Components
Semiconductor Substrate
Package Substrate
Temp. Components
200
200
304
500B
400
104
110

FIG. 2